



COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
9	PCB LAYOUT, PER REEL 2000 pcs, etc	H.A	R.K	07.01.25					
13	REVISED DIMENSION	H.A	K.1	07.01.31					
4	REVISED CONFIGURATION	H.A	T.T	07.03.06					

PCB LAYOUT
 *General tolerance is ±0.05mm.

DRAWING FOR PACKING (2 : 1)

RECOMMENDED PANEL CUTOUT (4 : 1)

MATED WITH CORRESPONDING PLUG (4 : 1)

REEL (FREE)

- NOTES
- CO-PLANARITY IS WITHIN 0.08 mm.
 - PLATING
 CONTACT AREA : GOLD 0.75µm min.
 LEAD AREA : GOLD 0.03µm min.
 UNDER PLATING : NICKEL 2µm min.
 - PER REEL : 2000 pcs.
 - INTERFACE DIMENSIONS CONFORM TO USB2.0 SPECIFICATION.

NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
2	COPPER ALLOY		3	STAINLESS STEEL	TIN PLATING 1µm min.
1	LCP	BLACK, UL94V-0			LUBRICANT

5	PE	
4	PS	

DRAWN	DESIGNED	CHECKED	APPROVED	RELEASED
H. ANDO	H. ANDO	H. KOBAYASHI	A. SUZUKI	07.3.6
06.12.28	06.12.28	06.12.28	06.12.28	DEPT

SCALE	DRAWING NO.	PART NO.
5 : 1	TEDC3-123598-01	ZX62-B-5P
UNITS	HIROSE ELECTRIC CO., LTD	CODE NO.
MM		CL242-0026-2

TO

FORM NO. 229